1/4, 1/3-Duty LCD Driver with Key Input Function

Overview

The LC75886PW is 1/4 duty and 1/3 duty LCD display driver that can directly drive up to 224 segments and can control up to 5 generalpurpose output ports. This product also incorporates a key scan circuit that accepts input from up to 30 keys to reduce printed circuit board wiring.

Features

- Key input function for up to 30 keys (A key scan is performed only when a key is pressed.)
- 1/4 duty 1/3 bias and 1/3 duty 1/3 bias drive schemes can be controlled from serial data.
- Capable of driving up to 224 segments using 1/4 duty and up to 171 segments using 1/3 duty.
- Switching between key scan output and segment output can be controlled from serial data.
- The key scan operation enabled/disabled state can be controlled from serial data.
- Switching between segment output port and general-purpose output port can be controlled from serial data.
- Switching between general-purpose output port, clock output port, and segment output port can be controlled from serial data.
- (Up to 5 general-purpose output ports and up to one clock output port) • Serial data I/O supports CCB* format communication with the system controller. (Support 3.3 V and 5 V operation)
- Sleep mode and all segments off functions that are controlled from serial data.
- The frame frequency of the common and segment output waveforms can be controlled from serial data.
- Switching between RC oscillator operating mode and external clock operationg mode can be controlled from serial data.
- Direct display of display data without the use of a decoder provides high generality.
- Provision of an on-chip voltage-detection type reset circuit prevents incorrect displays.
- $\overline{\text{RES}}$ pin provided for forcibly initializing the IC internal circuits.



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SQFP80 12x12 / SQFP80

* Computer Control Bus (CCB) is an ON Semiconductor's original bus format and the bus addresses are controlled by ON Semiconductor.

ORDERING INFORMATION

See detailed ordering and shipping information on page 36 of this data sheet.

Specifications

Absolute Maximum Ratings at Ta = 25° C, V_{SS} = 0 V

| Parameter | Symbol | Conditions | Ratings | Unit |
|-----------------------------|---------------------|---|------------------------------|------|
| Maximum supply voltage | V _{DD} max | V _{DD} | -0.3 to +7.0 | V |
| Input voltage | V _{IN} 1 | CE, CL, DI, RES | –0.3 to +7.0 | V |
| | V _{IN} 2 | OSC, TEST, V _{DD} 1, V _{DD} 2, KI1 to KI5 | –0.3 to V _{DD} +0.3 | v |
| Output voltage | V _{OUT} 1 | DO | -0.3 to +7.0 | |
| | V _{OUT} 2 | OSC, S1 to S57, COM1 to COM4, KS1 to KS6, P1 to P5 | –0.3 to V _{DD} +0.3 | V |
| Output current | IOUT1 | S1 to S57 | 300 | μA |
| | IOUT2 | COM1 to COM4 | 3 | |
| | IOUT3 | KS1 to KS6 | 1 | mA |
| | IOUT ⁴ | P1 to P5 | 5 | |
| Allowable power dissipation | Pd max | Ta = 85°C | 200 | mW |
| Operating temperature | Topr | | -40 to +85 | °C |
| Storage temperature | Tstg | | -55 to +125 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Allowable Operating Ranges at Ta = -40 to +85°C, V_{SS} = 0 V

| Deverseder | | | | Linit | | |
|--|-------------------|--|--------------------|--------------------|--------------------|------|
| Parameter | Symbol | Conditions | min | typ | max | Unit |
| Supply voltage | V _{DD} | V _{DD} | 4.5 | | 6.0 | V |
| Input voltage | V _{DD} 1 | V _{DD} 1 | | 2/3V _{DD} | V _{DD} | |
| | V _{DD} 2 | V _{DD} 2 | | 1/3V _{DD} | V _{DD} | v |
| Input high level voltage | V _{IH} 1 | CE, CL, DI, RES | 0.4V _{DD} | | 6.0 | |
| | V _{IH} 2 | KI1 to KI5 | 0.6V _{DD} | | V _{DD} | V |
| | V _{IH} 3 | OSC: External clock operating mode | 0.4V _{DD} | | V _{DD} | |
| Input low level voltage | V _{IL} 1 | CE, CL, DI, RES | 0 | | 0.2V _{DD} | |
| | V _{IL} 2 | KI1 to KI5 | 0 | | 0.2V _{DD} | V |
| | V _{IL} 3 | OSC: External clock operating mode | 0 | | 0.2V _{DD} | |
| Recommended external resistor for RC oscillation | R _{OSC} | OSC: RC oscillation operating mode | | 39 | | kΩ |
| Recommended external capacitor for RC oscillation | C _{OSC} | OSC: RC oscillation operating mode | | 1000 | | pF |
| Guaranteed range of RC oscillation | fosc | OSC: RC oscillation operating mode | 19 | 38 | 76 | kHz |
| External clock operating frequency | ^f CK | OSC: External clock operating mode [Figure4] | 10 | 38 | 76 | kHz |
| External clock duty cycle | DCK | OSC: External clock operating mode [Figure4] | 30 | 50 | 70 | % |
| Data setup time | ^t ds | CL, DI [Figure2], [Figure3] | 160 | | | ns |
| Data hold time | ^t dh | CL, DI [Figure2], [Figure3] | 160 | | | ns |
| CE wait time | t _{cp} | CE, CL [Figure2], [Figure3] | 160 | | | ns |
| CE setup time | t _{cs} | CE, CL [Figure2], [Figure3] | 160 | | | ns |
| CE hold time | ^t ch | CE, CL [Figure2], [Figure3] | 160 | | | ns |
| High level clock pulse width | t _{¢H} | CL [Figure2], [Figure3] | 160 | | | ns |
| Low level clock pulse width | t _{φL} | CL [Figure2], [Figure3] | 160 | | | ns |
| Rise time | t _r | CE, CL, DI [Figure2], [Figure3] | | 160 | | ns |
| Fall time | t _f | CE, CL, DI [Figure2], [Figure3] | | 160 | | ns |
| DO output deley time | ^t dc | DO R _{PU} = 4.7 kΩ C _L = 10 pF *1 [Figure2], [Figure3] | | | 1.5 | μS |
| DO rise time | tdr | DO R _{PU} = 4.7 k Ω C _L = 10 pF *1 [Figure 2] [Figure 3] | | | 1.5 | μS |

Note: *1 Since the DO pin is an open-drain output, these times depend on the values of the pull-up resistor R_{PU} and the load capacitance C_L .

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Electrical Characteristics for the Allowable Operating Ranges

| | Currente e l | | | | Ratings | | | |
|--------------------------------|--------------------|-----------------|---|----------------------------|----------------------|----------------------------|------|--|
| Parameter | Symbol | Pin | Conditions | | typ | max | Unit | |
| Hysteresis | V _H 1 | CE, CL, DI, RES | | | 0.03V _{DD} | | | |
| | V _H 2 | KI1 to KI5 | | | 0.1V _{DD} | | V | |
| Power-down detection voltage | VDET | | | 2.0 | 2.3 | 2.6 | V | |
| Input high level | I _{IH} 1 | CE, CL, DI, RES | V _I = 6.0 V | | | 5.0 | | |
| current | I _{IH} 2 | OSC | VI = VDD : External clock | | | 5.0 | μA | |
| | | | operating mode | | | 5.0 | | |
| Input low level | lı∟1 | CE, CL, DI, RES | V _I = 0 V | -5.0 | | | | |
| current | IIL2 | OSC | V _I = 0 V : External clock operating mode | -5.0 | | | μA | |
| Input floating voltage | VIF | KI1 to KI5 | | | | 0.05V _{DD} | V | |
| Pull-down resistance | RPD | KI1 to KI5 | V _{DD} = 5.0 V | 50 | 100 | 250 | kΩ | |
| Output off leakage current | IOFFH | DO | V _O = 6.0 V | | | 6.0 | μA | |
| Output high level | V _{OH} 1 | KS1 to KS6 | I _O = –500 μA | V _{DD} -1.0 | V _{DD} -0.5 | V _{DD} -0.2 | | |
| voltage | V _{OH} 2 | P1 to P5 | I _O = -1 mA | V _{DD} -0.9 | | | v | |
| | VOH3 | S1 to S57 | I _O = -20 μA | V _{DD} -0.9 | | | | |
| | V _{OH} 4 | COM1 to COM4 | I _O = -100 μA | V _{DD} -0.9 | | | | |
| Output low level | V _{OL} 1 | KS1 to KS6 | I _O = 25 μA | 0.2 | 0.5 | 1.5 | | |
| voltage | V _{OL} 2 | P1 to P5 | I _O = 1 mA | | | 0.9 | 1 | |
| | V _{OL} 3 | S1 to S57 | I _O = 20 μA | | | 0.9 | V | |
| | V _{OL} 4 | COM1 to COM4 | I _O = 100 μA | | | 0.9 | 1 | |
| | V _{OL} 5 | DO | I _O = 1 mA | | 0.1 | 0.3 | ĺ | |
| Output middle level voltage | V _{MID} 1 | S1 to S57 | 1/3 bias I _O = $\pm 20 \ \mu$ A | 2/3V _{DD} _0.9 | | 2/3V _{DD} +0.9 | | |
| *2 | V _{MID} 2 | S1 to S57 | 1/3 bias I _O = $\pm 20 \ \mu A$ | 1/3V _{DD} | | 1/3V _{DD} | | |
| | VAUD3 | COM1 to COM4 | 1/3 bize Lo = +100A | -0.9 2/3\/pp | | +0.9 | V | |
| | V MIDS | | $1/3$ bias $10^{-1} \pm 100 \mu$ A | _0.9 | | 2/3 V D D +0 9 | | |
| | V _{MID} 4 | COM1 to COM4 | 1/3 bias I _O = ±100 μA | 1/3V | | 1/3V | | |
| | | | 0 . | -0.9 | | +0.9 | | |
| Oscillator frequency | fosc | OSC | R_{OSC} = 39 kΩ, C_{OSC} = 1000 pF RC oscillation operating mode | 30.4 | 38 | 45.6 | kHz | |
| Current drain | I _{DD} 1 | V _{DD} | Sleep mode | | | 100 | | |
| | I _{DD} 2 | V _{DD} | V _{DD} = 6.0 V, Output open, RC oscillation operating mode, f _{OSC} = 38 kHz | | 450 | 900 | | |
| | I _{DD} 3 | V _{DD} | $V_{DD} = 6.0 \text{ V}, \text{ Output open},$ External clock operating mode, f _{CK} = 38 kHz, V _{IH} 3 = 0.5V _{DD} , V _{IL} 3 = 0.1V _{DD} | | 550 | 1100 | μΑ | |

Note: *2. Excluding the bias voltage generation divider resistor built into the VDD1 and VDD2. (See [Figure 1])



Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. When CL is stopped at the low level



[Figure 2]

2. When CL is stopped at the high level



3. OSC pin clock timing in external clock operating mode



Package Dimensions

unit : mm

SPQFP80 12x12 / SQFP80 CASE 131AL ISSUE A



NOTE: The measurements are not to guarantee but for reference only.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



Pin Functions

| Symbol | Pin No. | Function | Active | I/O | Handling when unused |
|----------------------------------|----------------------|--|-------------|-----|----------------------------|
| S1/P1 to S4/P4 S5 to S53 | 79,80,1,2 3 to 51 | Segment outputs for displaying the display data transferred by serial data input. The S1/P1 to S4/P4 pins can be used as general-purpose output ports under serial data control. | - | 0 | OPEN |
| COM1 to COM3 COM4/S54 | 52 to 54 55 | Common driver outputs. The frame frequency is f _O [Hz]. The COM4/S54 pin can be used as a segment output in 1/3 duty. | - | 0 | OPEN |
| KS1/S55 KS2/S56 KS3 to KS6 | 56 57 58 to 61 | Key scan outputs. Although normal key scan timing lines require diodes to be inserted in the timing lines to prevent shorts, since these outputs are unbalanced CMOS transistor outputs, these outputs will not be damaged by shorting when these outputs are used to form a key matrix. The KS1/S55 and KS2/S56 pins can be used as segment outputs when so specified by the control data. | - | 0 | OPEN |
| KI1 to KI5 | 62 to 66 | Key scan inputs. These pins have built-in pull-down resistors. | Н | I | GND |
| P5/S57 | 67 | General-purpose output port. This pin can be used as clock output port or segment output port under serial data control. | - | о | OPEN |
| OSC | 73 | Oscillator connections. An oscillator circuit is formed by connecting an external resistor and capacitor at this pin. This pin can also be used as the external clock input pin if the external clock operating mode is selected with the control data. | - | I/O | V _{DD} |
| CE | 76 | Serial data interface connections to the controller. Note that DO, being an | н | I | |
| CL | 77 | open-drain output, requires a pull-up resistor. CE: Chin enable | \bigwedge | I | GND |
| DI | 70 | CL: Synchronization clock | | | |
| | 70 | DI: Transfer data | - | - | |
| DO | 75 | DO: Output data | - | 0 | OPEN |
| RES | 74 | Reset signal input Reset signal input Reset signal input Reset solution input (These pins are forcibly set to the segment output port function and fixed at the low level.) S5 to S53=Low COM1 to COM3=Low COM4/S54=Low (This pin is forcibly set to the common output function and fixed at the low level.) P5/S57=Low (This pin is forcibly set to the general-purpose output port function and fixed at the low level.) KS3 to KS6=Low Key scanning disabled All the key data is reset to low. OSC="Z"(High impedance) RC oscillation stopped Inhibits external clock input RES=High ··· Display on General-purpose output port state setting is enabled Key scanning is enabled. RC oscillation enabled (RC oscilltator operating mode) Enables external clock input (external clock operating mode) | L | Ι | V _{DD} |
| TEST | 72 | This pin must be connected to ground. | - | I | - |
| V _{DD} 1 | 69 | Used to apply the LCD drive 2/3 bias voltage externally. | - | 1 | OPEN |
| V _{DD} 2 | 70 | Used to apply the LCD drive 1/3 bias voltage externally. | - | I | OPEN |
| V _{DD} | 68 | Power supply connections. Provide a voltage of between 4.5 to 6.0 V. | - | | - |
| V _{SS} | 71 | Power supply connections. Connect to ground. | - | - | - |

Serial Data Input

1. 1/4 duty

(1) When CL is stopped at the low level



Note: B0 to B3, A0 to A3 CCB address DD Direction data

(2) When CL is stopped at the high level

| CE | | | | | | L |
|----|--|-------------|------------------------|---|---|---|
| CL | uuuuu | | | | | |
| DI | <u>X0X1X0X0X0X0X1X0</u> | XD1XD2X | | | (PC51XKSCXS0XS1XK0XK1XP0XP1 | |
| DO | BU BT BZ B3 AU AT AZ A3 | | Display data (56 bits) | | Control data (15 bits) | (3 bits) |
| | | | | | | |
| | <u>}</u> | | | | | L |
| | unnun u | | | | | |
| | | XD57XD58X | | | | |
| | | | Display data (56 bits) | | Control data (15 bits) | (3 bits) |
| | | | | | | |
| | | | | | | Ļ |
| | unnun u | | | | | |
| | $\frac{2}{2}$ X O X 1 X O X O X O X O X O X 1 X O | XD113XD114X | | | (o X o X o X o X o X o X o X o X o X o X | |
| | | | Display data (56 bits) | | Fixed data (13 bits) | (3 bits) |
| | | | | | | |
| | <u>}</u> | | | | | |
| | · Manana and a second s | | | | | |
| | ² ∑0 X 1 X 0 X 0 X 0 X 0 X 1 X 0 5 B0 B1 B2 B3 A0 A1 A2 A3 | XD169XD170X | | <pre>(D222XD223XD224X O X O X O X O X O X</pre> | <u>⟨ 0 </u> | $\frac{\langle 0 \rangle 0 \rangle 0 \rangle 1 \rangle 1 \rangle}{\longrightarrow} \leq DD >$ |
| | <u>}</u> | | | | | (3 bits) |

Note: B0 to B3, A0 to A3 CCB address DD Direction data

- CCB address ··········42H"
- D1 to D224Display data
- OC ·····RC oscillator operating mode/external clock operationg mode switching control data
- PC50, PC51 ······ General-purpose output port/clock output port/segment output port switching control data
- KSC Key scan operation enabled/disabled state setting control data
- S0, S1 ····· Sleep control data
- K0, K1 ······Key scan output/segment output switching control data
- P0 to P2Segment output port/general-purpose output port switching control data
- SC ····· Segment on/off control data
- FC0 to FC2Common and segment output waveform frame frequency control data

2. 1/3 duty(1) When CL is stopped at the low level



Note: B0 to B3, A0 to A3 ······ CCB address DD ····· Direction data

(2) When CL is stopped at the high level

| CE | | | | | | |
|----|-----------------------------------|--------------------|--|---|---------------------------------|--|
| CL | | | | | | |
| DI | X0X1X0X0X0X0X1X0 | XD1XD2X 3 < | XD47XD48XD49XD50XD51XD52XD5 | 3\D54\D55\D56\D57\OC\PC50\P0 | تهزير Control data (12 bits) | |
| DO | | | | | | (3 bits) |
| | 2 | | | | | |
| | | | | | | |
| | 2 2 80 81 82 83 40 41 42 43 | XD58XD59X | XD104XD105XD106XD107XD108XD109XD11 Display data (57 bits) | 0 <u>XD111XD112XD113XD114X</u> 0 X 0 X 0 →i<── |) | |
| | <u>}</u> | | | | | (3 bits) |
| | } | | | | | |
| | | | | | | |
| | <pre> ¿</pre> | XD115XD116X 3 ← | XD161XD162XD163XD164XD165XD166XD16 Display data (57 bits) | 7XD168XD169XD170XD171X O X O X C |) | $\frac{\langle 0 \rangle 0 \langle 1 \rangle 1 \rangle 0 \rangle}{\Rightarrow < DD >}$ |
| | 2 | | , | | · · · · | (3 bits) |

Note: B0 to B3, A0 to A3 CCB address

DD Direction data

- CCB address ·······"42H"
- D1 to D171 ····· Display data
- OCRC oscillator operating mode/external clock operationg mode switching control data
- PC50, PC51 General-purpose output port/clock output port/segment output port switching control data
- KSCKey scan operation enabled/disabled state setting control data
- S0, S1 ····· Sleep control data
- K0, K1 Key scan output/segment output switching control data
- P0 to P2 Segment output port/general-purpose output port switching control data
- SC ····· Segment on/off control data
- FC0 to FC2 Common and segment output waveform frame frequency control data

Control Data Functions

- 1. OC ... RC oscillator operating mode/external clock operating mode switching control data
- This control data bit selects the OSC pin function (RC oscillator operating mode or external clock operating mode)

| OC | OSC pin function | | | |
|----|-------------------------------|--|--|--|
| 0 | RC oscillator operating mode | | | |
| 1 | External clock operating mode | | | |

Note: If RC oscillator operating mode is selected, connect an external resistor R_{OSC} and an external capacitor C_{OSC} to the OSC pin.

2. PC50, PC51 ... General-purpose output port/clock output port/segment output port switching control data These control data bits swithes the functions of the P5/S57 output pin between the general-purpose output port, the clock output port, and the segment output port.

| Control data | | The state of DE/CE7 suitaut air | |
|-------------------------------|------|--|--|
| PC50 | PC51 | | |
| 0 | 0 | General-purpose output port (P5) ("L" level output) | |
| 1 | 0 | General-purpose output port (P5) ("H" level output) | |
| 0 | 1 | Clock output port (P5) (Clock frequency is $f_{OSC}/2$ or $f_{CK}/2$) | |
| 1 1 Segment output port (S57) | | | |

Note: If the sleep mode is set, the P5/S57 output pin can not be used as the clock output port.

3. KSC \dots Key scan operation enabled/disabled state setting control data

This control data bit enables or disables key scan operation.

| KSC | Key scan operating state |
|-----|---|
| 0 | Key scan operation enabled (A key scan operation is performed if any key on the lines corresponding to KS1 to KS6 pin which is set high is pressed.) |
| 1 | Key scan operation disabled (No key scan operation is performed, even if any of the keys in the key matrix are pressed. If this state is set up, the key data is forcibly reset to 0 and the key data read request is also cleared. (DO is set high.)) |

4. S0, S1 ... Sleep control data

These control data bits switch between normal mode and sleep mode, and set the states of the KS1 to KS6 key scan output during key scan standby.

| Control data | | | OSC pin state Segment | | Output pin states during key scan standby | | | | | | |
|--------------|----|--------|---|------------------------------|---|-----|-----|-----|-----|-----|--|
| S0 | S1 | Mode | (RC oscillator or acceptance of the external clock signal) | output / Common output | KS1 | KS2 | KS3 | KS4 | KS5 | KS6 | |
| 0 | 0 | Normal | Operating | Operating | Н | н | Н | Н | н | н | |
| 0 | 1 | Sleep | Stopped | L | L | L | L | L | L | Н | |
| 1 | 0 | Sleep | Stopped | L | L | L | L | L | Н | Н | |
| 1 | 1 | Sleep | Stopped | L | Н | Н | Н | Н | Н | Н | |

Note: This assumes that the KS1/S55 and KS2/S56 output pins are selected for key scan output.

5. K0, K1 ... Key scan output/segment output switching control data

These control data bits switch the functions of the KS1/S55 and KS2/S56 output pins between the key scan output and the segment output.

| Contr | ol data | Output | pin state | Maximum number | | | | | | |
|---------|---------|---------|-----------|----------------|--|--|--|--|--|--|
| К0 | K1 | KS1/S55 | KS2/S56 | of input keys | | | | | | |
| 0 | 0 | KS1 | KS2 | 30 | | | | | | |
| 0 | 1 | S55 | KS2 | 25 | | | | | | |
| 1 | х | S55 | S56 | 20 | | | | | | |
| 37 1 1. | | | | | | | | | | |

Note: KSn (n=1 or 2): Key scan output Sn (n=55 or 56): Segment output

X : don't care

6. P0 to P2 ... Segment output port/general-purpose output port switching control data

These control data bits switch the functions of the S1/P1 to S4/P4 output pins between the segment output port and the general-purpose output port.

| | | L | | | | | | |
|----|-----------|-----|------------------|-------|-------|-------|--|--|
| Co | ontrol da | ata | Output pin state | | | | | |
| P0 | P1 | P2 | S1/P1 | S2/P2 | S3/P3 | S4/P4 | | |
| 0 | 0 | 0 | S1 | S2 | S3 | S4 | | |
| 0 | 0 | 1 | P1 | S2 | S3 | S4 | | |
| 0 | 1 | 0 | P1 | P2 | S3 | S4 | | |
| 0 | 1 | 1 | P1 | P2 | P3 | S4 | | |
| 1 | 0 | 0 | P1 | P2 | P3 | P4 | | |

Note: Sn (n=1 to 4): Segment output port Pn (n=1 to 4): General-purpose output port

The table below lists the correspondence between the display data and the output pins when these pins are selected to be general-purpose output ports.

| Outrast alia | Correspondence display data | | | |
|--------------|-----------------------------|----------|--|--|
| Output pin | 1/4 duty | 1/3 duty | | |
| S1/P1 | D1 | D1 | | |
| S2/P2 | D5 | D4 | | |
| S3/P3 | D9 | D7 | | |
| S4/P4 | D13 | D10 | | |

For example, if the circuit is operated in 1/4 duty and the S4/P4 output pin is selected to be a general-purpose output port, the S4/P4 output pin will output a high level when the display data D13 is 1, and will output a low level when D13 is 0.

7. SC ... Segment on/off control data

This control data bit controls the on/off state of the segments.

| SC | Display state | | |
|----|---------------|--|--|
| 0 | On | | |
| 1 | Off | | |

However, note that when the segments are turned off by setting SC to 1, the segments are turned off by outputting segment off waveforms from the segment output pins.

8. FC0 to FC2 \ldots Common and segment output waveform frame frequency control data

These control data bits set the common and segment output waveform frequency.

| C | Control dat | ta | Frame frequency f _O [Hz] | |
|-----|-------------|-----|---|--|
| FC0 | FC1 | FC2 | | |
| 1 | 1 | 0 | f _{OSC} /768, f _{CK} /768 | |
| 1 | 1 | 1 | f _{OSC} /576, f _{CK} /576 | |
| 0 | 0 | 0 | f _{OSC} /384, f _{CK} /384 | |
| 0 | 0 | 1 | f _{OSC} /288, f _{CK} /288 | |
| 0 | 1 | 0 | f _{OSC} /192, f _{CK} /192 | |

Display Data and Output Pin Correspondence

1. 1/4 duty

Output pin COM1 COM2 COM3 COM4 Output pin COM1 COM2 COM3 COM4 S1/P1 D1 D2 D3 D4 D113 D114 D115 D116 S29 S2/P2 D5 D6 D7 D8 S30 D117 D118 D119 D120 S3/P3 D9 D10 D11 D12 S31 D121 D122 D123 D124 S4/P4 D13 D14 D15 D16 S32 D125 D126 D127 D128 S5 D17 D18 D19 D20 S33 D129 D130 D131 D132 D22 D23 D24 S34 D134 D136 S6 D21 D133 D135 S7 D25 D26 D27 D28 S35 D137 D138 D139 D140 D29 D30 D32 S36 D141 D142 D143 D144 S8 D31 S9 D33 D34 D35 D36 S37 D145 D146 D147 D148 S10 D37 D38 D39 D40 S38 D149 D150 D151 D152 D42 D156 S11 D41 D43 D44 S39 D153 D154 D155 S12 D45 D46 D47 D48 S40 D157 D158 D159 D160 D50 D52 S41 D161 D162 D164 S13 D49 D51 D163 S14 D53 D54 D55 D56 S42 D165 D166 D167 D168 S15 D57 D58 D59 D60 S43 D169 D170 D171 D172 S16 D61 D62 D63 D64 S44 D173 D174 D175 D176 S17 D65 D66 D67 D68 S45 D177 D178 D179 D180 S46 D182 D184 S18 D69 D70 D71 D72 D181 D183 S19 D73 D74 D75 D76 S47 D185 D186 D187 D188 S20 D77 D78 D79 D80 S48 D189 D190 D191 D192 S21 D81 D82 D83 D84 S49 D193 D194 D195 D196 S22 D85 D86 D87 D88 S50 D197 D198 D199 D200 D89 D90 D91 D92 S51 D201 D202 D204 S23 D203 S24 D93 D94 D95 D96 S52 D205 D206 D207 D208 S25 D100 S53 D210 D212 D97 D98 D99 D209 D211 S26 D101 D102 D103 D104 KS1/S55 D213 D214 D215 D216 S27 D105 D106 D107 D108 KS2/S56 D217 D218 D219 D220 D109 D112 P5/S57 S28 D110 D111 D221 D222 D223 D224

Note: This is for the case where the S1/P1 to S4/P4, KS1/S55, KS2/S56, P5/S57 output pins are selected for use as segment outputs.

For example, the table below lists the segment output states for the S11 output pin.

| | Displa | y data | | Output pin state (S11) | |
|-----|--------|--------|-----|---|--|
| D41 | D42 | D43 | D44 | | |
| 0 | 0 | 0 | 0 | The LCD segments for COM1, COM2, COM3 and COM4 are off. | |
| 0 | 0 | 0 | 1 | The LCD segment for COM4 is on. | |
| 0 | 0 | 1 | 0 | The LCD segment for COM3 is on. | |
| 0 | 0 | 1 | 1 | The LCD segments for COM3 and COM4 are on. | |
| 0 | 1 | 0 | 0 | The LCD segment for COM2 is on. | |
| 0 | 1 | 0 | 1 | The LCD segments for COM2 and COM4 are on. | |
| 0 | 1 | 1 | 0 | The LCD segments for COM2 and COM3 are on. | |
| 0 | 1 | 1 | 1 | The LCD segments for COM2, COM3 and COM4 are on. | |
| 1 | 0 | 0 | 0 | The LCD segment for COM1 is on. | |
| 1 | 0 | 0 | 1 | The LCD segments for COM1 and COM4 are on. | |
| 1 | 0 | 1 | 0 | The LCD segments for COM1 and COM3 are on. | |
| 1 | 0 | 1 | 1 | The LCD segments for COM1, COM3 and COM4 are on. | |
| 1 | 1 | 0 | 0 | The LCD segments for COM1 and COM2 are on. | |
| 1 | 1 | 0 | 1 | The LCD segments for COM1, COM2 and COM4 are on. | |
| 1 | 1 | 1 | 0 | The LCD segments for COM1, COM2 and COM3 are on. | |
| 1 | 1 | 1 | 1 | The LCD segments for COM1, COM2, COM3 and COM4 are on. | |

2. 1/3 duty

| Output pin | COM1 | COM2 | COM3 |
|------------|------|------|------|
| S1/P1 | D1 | D2 | D3 |
| S2/P2 | D4 | D5 | D6 |
| S3/P3 | D7 | D8 | D9 |
| S4/P4 | D10 | D11 | D12 |
| S5 | D13 | D14 | D15 |
| S6 | D16 | D17 | D18 |
| S7 | D19 | D20 | D21 |
| S8 | D22 | D23 | D24 |
| S9 | D25 | D26 | D27 |
| S10 | D28 | D29 | D30 |
| S11 | D31 | D32 | D33 |
| S12 | D34 | D35 | D36 |
| S13 | D37 | D38 | D39 |
| S14 | D40 | D41 | D42 |
| S15 | D43 | D44 | D45 |
| S16 | D46 | D47 | D48 |
| S17 | D49 | D50 | D51 |
| S18 | D52 | D53 | D54 |
| S19 | D55 | D56 | D57 |
| S20 | D58 | D59 | D60 |
| S21 | D61 | D62 | D63 |
| S22 | D64 | D65 | D66 |
| S23 | D67 | D68 | D69 |
| S24 | D70 | D71 | D72 |
| S25 | D73 | D74 | D75 |
| S26 | D76 | D77 | D78 |
| S27 | D79 | D80 | D81 |
| S28 | D82 | D83 | D84 |
| S29 | D85 | D86 | D87 |
| S30 | D88 | D89 | D90 |

| Output pin | COM1 | COM2 | COM3 |
|------------|------|------|------|
| S31 | D91 | D92 | D93 |
| S32 | D94 | D95 | D96 |
| S33 | D97 | D98 | D99 |
| S34 | D100 | D101 | D102 |
| S35 | D103 | D104 | D105 |
| S36 | D106 | D107 | D108 |
| S37 | D109 | D110 | D111 |
| S38 | D112 | D113 | D114 |
| S39 | D115 | D116 | D117 |
| S40 | D118 | D119 | D120 |
| S41 | D121 | D122 | D123 |
| S42 | D124 | D125 | D126 |
| S43 | D127 | D128 | D129 |
| S44 | D130 | D131 | D132 |
| S45 | D133 | D134 | D135 |
| S46 | D136 | D137 | D138 |
| S47 | D139 | D140 | D141 |
| S48 | D142 | D143 | D144 |
| S49 | D145 | D146 | D147 |
| S50 | D148 | D149 | D150 |
| S51 | D151 | D152 | D153 |
| S52 | D154 | D155 | D156 |
| S53 | D157 | D158 | D159 |
| COM4/S54 | D160 | D161 | D162 |
| KS1/S55 | D163 | D164 | D165 |
| KS2/S56 | D166 | D167 | D168 |
| P5/S57 | D169 | D170 | D171 |

Note: This is for the case where the S1/P1 to S4/P4, COM4/S54, KS1/S55, KS2/S56, P5/S57 output pins are selected for use as segment outputs.

For example, the table below lists the segment output states for the S11 output pin.

| | Display data | | Output air state (C11) | |
|-----|--------------|-----|--|--|
| D31 | D32 | D33 | Output pin state (STT) | |
| 0 | 0 | 0 | The LCD segments for COM1, COM2, and COM3 are off. | |
| 0 | 0 | 1 | The LCD segment for COM3 is on. | |
| 0 | 1 | 0 | The LCD segment for COM2 is on. | |
| 0 | 1 | 1 | The LCD segments for COM2 and COM3 are on. | |
| 1 | 0 | 0 | The LCD segment for COM1 is on. | |
| 1 | 0 | 1 | The LCD segments for COM1 and COM3 are on. | |
| 1 | 1 | 0 | The LCD segments for COM1 and COM2 are on. | |
| 1 | 1 | 1 | The LCD segments for COM1, COM2 and COM3 are on. | |

Serial Data Output



Note: If a key data read operation is executed when DO is high (DO does not generate a key data read request output), the read key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

Output Data

1. KD1 to KD30 ... Key data

When a key matrix of up to 30 keys is formed from the KS1 to KS6 output pins and KI1 to KI5 input pins and one of those keys is pressed, the key output data corresponding to that key will be set to 1. The table shows the relationship between those pins and the key data bits.

| | KI1 | KI2 | KI3 | Kl4 | KI5 |
|---------|------|------|------|------|------|
| KS1/S55 | KD1 | KD2 | KD3 | KD4 | KD5 |
| KS2/S56 | KD6 | KD7 | KD8 | KD9 | KD10 |
| KS3 | KD11 | KD12 | KD13 | KD14 | KD15 |
| KS4 | KD16 | KD17 | KD18 | KD19 | KD20 |
| KS5 | KD21 | KD22 | KD23 | KD24 | KD25 |
| KS6 | KD26 | KD27 | KD28 | KD29 | KD30 |

When the KS1/S55 and KS2/S56 output pins are selected to be segment outputs by control data bits K0 and K1 and a key matrix of up to 20 keys is formed using the KS3 to KS6 output pins and the KI1 to KI5 input pins, the KD1 to KD10 key data bits will be set to 0.

2. SA ... Sleep acknowledge data

This output data bit is set to the state when the key was pressed. Also, while DO will be low in this case, if serial data is input and the mode is set (to normal or sleep mode) during this period, that mode will be set. SA will be 1 in sleep mode and 0 in normal mode.

Sleep Mode Functions

Sleep mode is set up by setting S0 or S1 in the control data to 1. When sleep mode is set up, both the segment and common outputs will go to the low level. In RC oscillator operating mode (OC=0), the oscillator on the OSC pin will stop (although it will operate during key scan operations), and in exeternal clock operating mode (OC=1), acceptance of the external clock signal on the OSC pin will stop (although the clock signal will be accepted during key scan operations). Thus this mode reduces power consumption. However, the S1/P1 to S4/P4, P5/S57 output pins can be used as general-purpose output ports under control of the P0 to P2, PC50 and PC51 bits in the control data even in sleep mode (The P5/S57 output pin can not be used as clock output port). Sleep mode is cancelled by setting both S0 and S1 in control data to 0.

Key Scan Operation Functions

1. Key scan timing

The key scan period is 288T[s]. To reliably determine the on/off state of the keys, the LC75886PW scans the keys twice and determines that a key has been pressed when the key data agrees. It outputs a key data read request (a low level on DO) 615T[s] after starting a key scan. If the key data does not agree and a key was pressed at that point, it scans the keys again. Thus the LC75886PW cannot detect a key press shorter than 615T[s].



Note: *3. These are set to the high or low level by the S0 and S1 bits in the control data. Key scan output signals are not output from pins that are set to the low level.

2. Normal mode, when key scan operations are enabled

- (1) The KS1 to KS6 pins are set high. (See the description of the control data.)
- (2) When a key is pressed, a key scan is started and the keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.
- (3) If a key is pressed for longer than 615T[s] (Where T=1/f_{OSC} or T=1/f_{CK}), the LC75886PW outputs a key data read request (a low level on DO) to the controller. The controller acknowledges this request and reads the key data. However, if CE is high during a serial data transfer, DO will be set high.
- (4) After the controller reads the key data, the key data read request is cleared (DO is set high) and the LC75886PW performs another key scan. Also note that DO, being an open-drain output, requires a pull-up resistor (between 1 and $10 \text{ k}\Omega$).



3. Sleep mode, when key scan operations are enabled

(1) The KS1 to KS6 pins are set to high or low level by the S0 and S1 bits in the control data.

- (See the description of the control data.)
- (2) If a key on one of the lines corresponding to a KS1 to KS6 pin which is set high is pressed, the oscillator on the OSC pins starts in RC oscillator operating mode (the IC starts accepting the external clock signal in external clock operating mode) and a key scan is performed. Keys are scanned until all keys are released.
 Multiple here present are present in a whether multiple here data hits are set.

Multiple key presses are recognized by determining whether multiple key data bits are set.

- (3) If a key is pressed for longer than 615T[s] (Where T=1/fOSC or T=1/fCK), the LC75886PW outputs a key data read request (a low level on DO) to the controller. The controller acknowledges this request and reads the key data. However, if CE is high during a serial data transfer, DO will be set high.
- (4) After the controller reads the key data, the key data read request is cleared (DO is set high) and the LC75886PW performs another key scan. However, this does not clear sleep mode. Also note that DO, being an open-drain output, requires a pull-up resistor (between 1 and 10 kΩ).
- (5) Sleep mode key scan example

Example: S0=0, S1=1 (Sleep with only KS6 high)



When any one of these keys is pressed, the oscillator on the OSC pins starts in RC oscillator operating mode (the IC starts accepting the external clock signal in external clock operating mode) and a key scan operation is performed.

Note: *4. These diodes are required to reliably recognize multiple key presses on the KS6 line when sleep mode state with only KS6 high, as in the above example. That is, these diodes prevent incorrect operations due to sneak currents in the KS6 key scan output signal when keys on the KS1 to KS5 lines are pressed at the same time.



4. Normal/sleep mode, when key scan operations are disabled

- (1) The KS1 to KS6 pins are set to high or low level by the S0 and S1 bits in the control data.
- (2) No key scan operation is performed, whichever key is pressed.
- (3) If the key scan disabled state (KSC=1 in the control data) is set during a key scan, the key scan is stopped.
- (4) If the key scan disabled state (KSC=1 in the control data) is set when a key data read request (a low level on DO) is output to the controller, all the key data is set to 0 and the key data read request is cleared (DO is set high). Note that DO, being an open-drain output, requires a pull-up resister (between 1 to 10 kΩ).
- (5) The key scan disabled state is cleared by setting KSC in the control data to 0.



Multiple Key Presses

Although the LC75886PW is capable of key scanning without inserting diodes for dual key presses, triple key presses on the KI1 to KI5 input pin lines, or multiple key presses on the KS1 to KS6 output pin lines, multiple presses other than these cases may result in keys that were not pressed recognized as having been pressed. Therefore, a diode must be inserted in series with each key. Applications that do not recognize multiple key presses of three or more keys should check the key data for three or more 1 bits and ignore such data.

f_O[Hz]

1/4 Duty, 1/3 Bias Drive Technique

| | $\rightarrow \geq$ | |
|---|--------------------|---|
| COM1 | | |
| COM2 | | $\begin{array}{c} - & V_{DD} \\ - & V_{DD}^{1} \\ - & V_{DD}^{2} \\ - & 0V \end{array}$ |
| СОМЗ | | V_{DD} V_{DD} V_{DD} 0V |
| COM4 | | $ \begin{array}{c} V_{DD} \\ V_{DD}^{1} \\ V_{DD}^{2} \\ 0V \end{array} $ |
| LCD driver output when all LCD segments corresponding to COM1, COM2, COM3, and COM4 are turned off. | | $ \begin{array}{c} - & V_{DD} \\ - & V_{DD1} \\ - & V_{DD2} \\ - & 0V \end{array} $ |
| LCD driver output when only LCD segments corresponding to COM1 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when only LCD segments corresponding to COM2 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when LCD segments corresponding to COM1 and COM2 are on. | | |
| LCD driver output when only LCD segments corresponding to COM3 are on. | | $- V_{DD}$ $- V_{DD1}$ $- V_{DD2}$ - 0V |
| LCD driver output when LCD segments corresponding to COM1 and COM3 are on. | | V _{DD} V _{DD} 1 V _{DD} 2 0V |
| LCD driver output when LCD segments corresponding to COM2 and COM3 are on. | | V _{DD} V _{DD} 1 V _{DD} 2 0V |
| LCD driver output when LCD segments corresponding to COM1, COM2, and COM3 are on. | | V _{DD} V _{DD} 1 V _{DD} 2 0V |
| LCD driver output when only LCD segments corresponding to COM4 are on. | | V _{DD} V _{DD} 1 V _{DD} 2 0V |
| LCD driver output when LCD segments corresponding to COM2 and COM4 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when all LCD segments corresponding to COM1, COM2, COM3, and COM4 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| | | |

| (| Control data | | Common and segment output waveform | |
|-----|--------------|-----|---|--|
| FC0 | FC1 | FC2 | frame frequency f _O [Hz] | |
| 1 | 1 | 0 | f _{OSC} /768, f _{CK} /768 | |
| 1 | 1 | 1 | f _{OSC} /576, f _{CK} /576 | |
| 0 | 0 | 0 | f _{OSC} /384, f _{CK} /384 | |
| 0 | 0 | 1 | f _{OSC} /288, f _{CK} /288 | |
| 0 | 1 | 0 | f _{OSC} /192, f _{CK} /192 | |

| 1/3 Duty, 1/3 Bias Drive Technique | f _O [Hz] | |
|---|---------------------|---|
| COM1 | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| COM2 | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| СОМЗ | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when all LCD segments corresponding to COM1, COM2, and COM3 are turned off. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when only LCD segments corresponding to COM1 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when only LCD segments corresponding to COM2 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when LCD segments corresponding to COM1 and COM2 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when only LCD segments corresponding to COM3 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when LCD segments corresponding to COM1 and COM3 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when LCD segments corresponding to COM2 and COM3 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |
| LCD driver output when all LCD segments corresponding to COM1, COM2, and COM3 are on. | | — V _{DD} — V _{DD} 1 — V _{DD} 2 — 0V |

| Common and segment output waveform | Control data | | |
|---|--------------|-----|-----|
| frame frequency f _O [Hz] | FC2 | FC1 | FC0 |
| f _{OSC} /768, f _{CK} /768 | 0 | 1 | 1 |
| f _{OSC} /576, f _{CK} /576 | 1 | 1 | 1 |
| f _{OSC} /384, f _{CK} /384 | 0 | 0 | 0 |
| f _{OSC} /288, f _{CK} /288 | 1 | 0 | 0 |
| f _{OSC} /192, f _{CK} /192 | 0 | 1 | 0 |

Clock Signal Output Waveform

| Control data | | | |
|--------------|------|---|--|
| PC50 | PC51 | The state of P5/S57 output pin | |
| 0 | 1 | Clock output port (P5) (Clock frequency is f _{OSC} /2 or f _{CK} /2) | |
| P5 _ | | $\begin{array}{c} & \\ \hline \\$ | |

Voltage Detection Type Reset Circuit (VDET)

This circuit generates an output signal and resets the system when power is first applied and when the voltage drops, i.e., when the power supply voltage is less than or equal to the power down detection voltage V_{DET} , which is 2.3 V, typical. To assure that this function operates reliably, a capacitor must be added to the power supply line so that the power supply voltage V_{DD} rise time when the power is first applied and the power supply voltage V_{DD} fall time when the voltage drops are both at least 1ms. (See Figure 5 and Figure 6.)

System Reset

The LC75886PW supports the reset methods described below. When a system reset is applied, display is turned off, key scanning is stopped, all the key data is reset to low, and the general-purpose output ports are fixed at the low level (The S1/P1 to S4/P4 pins are forcibly set to the segment output port function and fixed at the low level. The P5/S57 pin is forcibly set to the general-purpose output port function and fixed at the low level). When the reset is cleared, display is turned on, key scanning is enabled and the general-purpose output ports state setting is enabled.

1. Reset methods

(1) Reset method by the voltage detection type reset circuit (VDET)

If at least 1ms is assured as the supply voltage V_{DD} rise time when power is applied, a system reset will be applied by the V_{DET} output signal when the supply voltage is brought up. If at least 1 ms is assured as the supply voltage V_{DD} fall time when power drops, a system reset will be applied in the same manner by the V_{DET} output signal when the supply voltage is lowered. Note that the reset is cleared at the point when all the serial data (1/4 duty: the display data D1 to D224 and the control data, 1/3 duty: the display data D1 to D171 and the control data) has been transferred, i.e., on the fall of the CE signal on the transfer of the last direction data, after all the direction data has been transferred. (See Figure 5 and Figure 6.)











(2) Reset method by the $\overline{\text{RES}}$ pin

When power is applied, a system reset is applied by setting the $\overline{\text{RES}}$ pin low level. The reset is cleared by setting the $\overline{\text{RES}}$ pin high level after all the serial data (1/4 duty: the display data D1 to D224 and the control data, 1/3 duty: the display data D1 to D171 and the control data) has been transferred.

In the allowable operating range ($V_{DD} = 4.5$ to 6.0 V), A reset is applied by setting the \overline{RES} pin low level. and the reset is cleared by setting the \overline{RES} pin high level

- 2. Internal block states during the reset period
- CLOCK GENERATOR

A reset is applied and either the OSC pin oscillator is stopped or external clock reception is stopped

- COMMON DRIVER, SEGMENT DRIVER & LATCH
- A reset is applied and the display is turned off. However, display data can be input to the latch circuit in this state. • KEY SCAN

A reset is applied, the circuit is set to the initial state, and at the same time the key scan operation is disabled.

- KEY BUFFER
- A reset is applied and all the key data is set to low.
- GENERAL PURPOSE PORT
 - A reset is applied, the circuit is set to the initial state.
- CCB INTERFACE, SHIFT REGISTER, CONTROL REGISTER Since serial data transfer is possible, these circuits are not reset.



3. Pin states during the reset period

| Pin | State during reset |
|------------------|--------------------|
| S1/P1 to S4/P4 | L *5 |
| S5 to S53 | L |
| COM1 to COM3 | L |
| COM4/S54 | L *6 |
| KS1/S55, KS2/S56 | L *5 |
| KS3 to KS6 | L *7 |
| P5/S57 | L *8 |
| OSC | Z *9 |
| DO | H *10 |

Note: *5. These output pins are forcibly set to the segment output function and held low.

- *6. This output pin is forcibly set to the common output function and held low.
- *7. These output pins are forcibly held fixed at the low level.
- *8. This output pin is forcibly set to the general-purpose output port function and held low.
- *9. This I/O pin is forcibly set to the high-impedance state.
- *10.Since this output pin is an open-drain output, a pull-up resistor of between 1 and 10 k Ω is required. This pin remains high during the reset period even if a key data read operation is performed.

Notes on the OSC Pin Peripheral Circuit

1. RC oscillator operationg mode (Control data bit OC = 0)

When RC oscillator operationg mode is selected, an external resistor R_{OSC} and an external capacitor C_{OSC} must be connected between the OSC pin and GND.



2. External clock operating mode (Control data bit OC = 1)

When selecting the external clock operating mode, connect a current protection resistor Rg (4.7 to 47 k Ω) between the OSC pin and the external clock output pin (external oscillator). Determine the value of the resistance according to the maximum allowable current value of the external clock output pin. Also make sure that the waveform of the external clock is not excessively distorted.



1/4 duty, 1/3 bias (for use with normal panels)



- Note: *11. Add a capacitor to the power supply line so that the power supply voltage V_{DD} rise time when power is applied and the power supply voltage V_{DD} fall time when power drops are both at least 1 ms, as the LC75886PW is reset by the V_{DET}.
 - *12. If the $\overline{\text{RES}}$ pin is not used for system reset, it must be connected to the power supply VDD.
 - *13. When RC oscillator operating mode is used, the external resistor R_{OSC} and the external capacitor C_{OSC} must be connected between the OSC pin and GND, and when external clock operating mode is selected the current protection resistor Rg (4.7 to 47 k Ω) must be connected between the OSC pin and the external clock output pin (external oscillator). (See the section on the OSC pin peripheral circuit.)
 - *14. The DO pin, being an open-drain output, requires a pull-up resistor. Select a resistance (between 1 to $10 \text{ k}\Omega$) appropriate for the capacitance of the external wiring so that signal waveforms are not degraded.
 - *15. The pins to be connected to the controller (CE, CL, DI, DO, $\overline{\text{RES}}$) can handle 3.3 V or 5 V.

1/4 duty, 1/3bias (for use with large panels)



- Note: *11. Add a capacitor to the power supply line so that the power supply voltage V_{DD} rise time when power is applied and the power supply voltage V_{DD} fall time when power drops are both at least 1 ms, as the LC75886PW is reset by the V_{DET}.
 - *12. If the $\overline{\text{RES}}$ pin is not used for system reset, it must be connected to the power supply VDD.
 - *13. When RC oscillator operating mode is used, the external resistor R_{OSC} and the external capacitor C_{OSC} must be connected between the OSC pin and GND, and when external clock operating mode is selected the current protection resistor Rg (4.7 to 47 k Ω) must be connected between the OSC pin and the external clock output pin (external oscillator). (See the section on the OSC pin peripheral circuit.)
 - *14. The DO pin, being an open-drain output, requires a pull-up resistor. Select a resistance (between 1 to $10 \text{ k}\Omega$) appropriate for the capacitance of the external wiring so that signal waveforms are not degraded.
 - *15. The pins to be connected to the controller (CE, CL, DI, DO, $\overline{\text{RES}}$) can handle 3.3 V or 5 V.

1/3 duty, 1/3 bias (for use with normal panels)



- Note: *11. Add a capacitor to the power supply line so that the power supply voltage V_{DD} rise time when power is applied and the power supply voltage V_{DD} fall time when power drops are both at least 1 ms, as the LC75886PW is reset by the V_{DET} .
 - *12. If the $\overline{\text{RES}}$ pin is not used for system reset, it must be connected to the power supply V_{DD}.
 - *13. When RC oscillator operating mode is used, the external resistor R_{OSC} and the external capacitor C_{OSC} must be connected between the OSC pin and GND, and when external clock operating mode is selected the current protection resistor Rg (4.7 to 47 k Ω) must be connected between the OSC pin and the external clock output pin (external oscillator). (See the section on the OSC pin peripheral circuit.)
 - *14. The DO pin, being an open-drain output, requires a pull-up resistor. Select a resistance (between 1 to 10 k Ω) appropriate for the capacitance of the external wiring so that signal waveforms are not degraded.
 - *15. The pins to be connected to the controller (CE, CL, DI, DO, $\overline{\text{RES}}$) can handle 3.3 V or 5 V.

1/3 duty, 1/3bias (for use with large panels)



- Note: *11. Add a capacitor to the power supply line so that the power supply voltage V_{DD} rise time when power is applied and the power supply voltage V_{DD} fall time when power drops are both at least 1 ms, as the LC75886PW is reset by the V_{DET}.
 - *12. If the $\overline{\text{RES}}$ pin is not used for system reset, it must be connected to the power supply VDD.
 - *13. When RC oscillator operating mode is used, the external resistor R_{OSC} and the external capacitor C_{OSC} must be connected between the OSC pin and GND, and when external clock operating mode is selected the current protection resistor Rg (4.7 to 47 k Ω) must be connected between the OSC pin and the external clock output pin (external oscillator). (See the section on the OSC pin peripheral circuit.)
 - *14. The DO pin, being an open-drain output, requires a pull-up resistor. Select a resistance (between 1 to 10 k Ω) appropriate for the capacitance of the external wiring so that signal waveforms are not degraded.
 - *15. The pins to be connected to the controller (CE, CL, DI, DO, $\overline{\text{RES}}$) can handle 3.3 V or 5 V.

Notes on Transferring Display Data from The Controller

When using the LC75886PW in 1/4 duty, applications transfer the display data (D1 to D224) in four operations, and in 1/3 duty, they transfer the display data (D1 to D171) in three operations. In either case, applications should transfer all of the display data within 30 ms to maintain the quality of displayed image.

Notes on the Controller Key Data Read Techniques

- 1. Timer based key data acquisition
- (1) Flowchart



(2) Timing chart



- t3 Key scan execution time when the key data agreed for two key scans. (615T[s])
- t4 Key scan execution time when the key data did not agree for two key scans and the key scan was executed again. (1230T[s])
- t5 ····· Key address (43H) transfer time
- t6 ····· Key data read time

 $T = \frac{1}{f_{OSC}} = \frac{1}{f_{CK}}$

(3) Explanation

In this technique, the controller uses a timer to determine key on/off states and read the key data. The controller must check the DO state when CE is low every t7 period without fail. If DO is low, the controller recognizes that a key has been pressed and executes the key data read operation.

The period t7 in this technique must satisfy the following condition.

t7>t4+t5+t6

If a key data read operation is executed when DO is high (DO does not generate a key data read request output), the read key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

2. Interrupt based key data acquistion

(1) Flowchart



(2) Timing chart



- t3 \cdots Key scan execution time when the key data agreed for two key scans. (615T[s])
- t4 Key scan execution time when the key data did not agree for two key scans and the key scan was executed again. (1230T[s])
- t5 Key address (43H) transfer time
- t6 ····· Key data read time

 $T = \frac{1}{f_{OSC}} = \frac{1}{f_{CK}}$

(3) Explanation

In this technique, the controller uses interrupts to determine key on/off states and read the key data.

The controller must check the DO state when CE is low. If DO is low, the controller recognizes that a key has been pressed and executes the key data read operation. After that the next key on/off determination is performed after the time t8 has elapsed by checking the DO state when CE is low and reading the key data. The period t8 in this technique must satisfy the following condition.

t8>t4

If a key data read operation is executed when DO is high (DO does not generate a key data read request output), the read key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

About Data Communication Method with The Controller

1. About data communication method of 4 line type CCB format

The 4 line type CCB format is the data communication method of before. The LC75886PW must connect to the controller as followings.



2. About data communication method of 3 line type CCB format

The 3 line type CCB format is the data communication method that made a common use of the data input DI in the data output DO. The LC75886PW must connect to the controller as followings.



In this case, Applications must transfer the data communication start command before the serial data input (CCB address "42H", display data and control data transfer) or serial data output (CCB address "43H" transfer, key data read) to avoid the collision of the data input signal DI and the data output signal DO.

Then applications must transfer the data communication stop command when the controller wants to detect the key data read request signal (a low level on DO) during a movement stop of the serial data input and the serial data output.



(1) When CL is stopped at the low level



<2> Data communication stop command (1) When CL is stopped at the low level





(2) When CL is stopped at the high level

(2) When CL is stopped at the high level



Data Communication Flowchart of 4 Line Type or 3 Line Type CCB Format

1. Flowchart of the initial setting when power is turned on.



2. Flowchart of the serial data input



Note: The flowchart of initial setting when power is turned on is same regardless of the 4 line type or 3 line type CCB format. Take explanation about "system reset" into account.

Note: *18. In the case of the 4 line type CCB format, the transfers of data communication start command and data communication stop command are unnecessary, and, in the case of the 3 line type CCB format, these transfers are necessary.

3. Flowchart of the serial data output



- Note: *19. In the case of the 4 line type CCB format, the transfer of data communication start command is unnecessary, and, in the case of the 3 line type CCB format, the transfer is necessary.
 - *20. Because the serial data output has the role of the data communication stop command, it is not necessary to transfer the data communication stop command some other time.

Timing Chart of 4 Line Type and 3 Line Type CCB Format

1. Timing chart of 4 line type CCB format



And, when the key data does not agree for two key scans and the key scan is executed again, the key scan execution time is 1230T[s].



2. Timing chart of 3 line type CCB format



Note: *21. When the key data agrees for two key scans, the key scan execution time is 615T[s]. And, when the key data does not agree for two key scans and the key scan is executed again, the key scan execution time is 1230T[s].

 $T = \frac{1}{fOSC} = \frac{1}{fCK}$

ORDERING INFORMATION

| Device | Package | Shipping (Qty / Packing) |
|--------------|---|--------------------------|
| LC75886PW-H | SQFP80 12x12 / SQFP80 (Pb-Free / Halogen Free) | 300 / Tray Foam |
| LC75886PWH-H | SQFP80 12x12 / SQFP80 (Pb-Free / Halogen Free) | 300 / Tray Foam |

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